_ AS	PC SSOCIATION CONNECTING ECTRONICS INDUSTRIES®	© Copyright 2005. IPC, Bannockburn, Illinois. All rights reserved under engineering responsibility.							e manufacturer has
l l		IPC Web Site for Information on http://www.ipc.org/IPC-175x	C Web Site for Information on IPC-1752 Standard p://www.ipc.org/IPC-175x			Declaration Class *			
Su	pplier Information								
Company Name *		Company Unique ID	Unique ID Authority	Response Dat	Response Date *		ument ID		
Contact Name *		Title - Contact	Phone - Contact *		Email - Contact *				
Authorized Representativ		ve * Title - Representative	Phone - Representative *	Email - Repres	Email - Representative *		Supplier Comments or URL for Additional Information		
	Requester Item Number	Mfr Item Number	Mfr Item Name	Effective Date	Version	Manufacturing Site	Weight	UOM	Unit Type
	Alternate Recommenda	dation Alternate Item Comments		Item Comments					

Manufacturing Information section intentionally omitted.

this form to a file	Import fields from a file into this form	Clear all of the fields on this form	form to prevent changes							
RoHS Material Co	omposition Declaration		Declaration Type *							
RoHS Definition: Quantity limit of 0.1% by mass (1000 PPM) in homogeneous material for: Lead (Pb), Mercury, Hexavalent Chromium, Polybrominated Biphenyls (PBB), Polybrominated Diphenyl Ethers (PBDE) and quantity limit of 0.01% by mass (100 PPM) of homogeneous material for Cadmium										
RoHS Declaration *			Supplier Acceptance							
	clared item does not contain RoHS restricted substances per the definition at will appear below. Check all applicable exemptions.	pove except for defined RoHS exemptions, the	en select the corresponding respon	se in the RoHS Declaration						
1. Mercury in compact f	fluorescent lamps not exceeding 5 mg per lamp.	7c. Lead in electronic ceramic parts (e.g. pie	zoelectronic devices).							
2a. Mercury in straight f halophosphate lamps	fluorescent lamps for general purposes not exceeding 10 mg. in	8. Cadmium and its compounds in electrical contacts and cadmium plating except for applications banned under Directive 91/338/EEC amending Directive 76/769/EEC relating to restrictions on the marketing and use of certain dangerous substances and preparations piezoelectronic devices).								
2b. Mercury in straight f lamps with a normal life	fluorescent lamps for general purposes not exceeding 5 mg. in triphosphate etime	<ol><li>Hexavalent chromium as an anti-corrosion of the carbon steel cooling system in absorption refrigerators</li></ol>								
2c. Mercury in straight f lamps with long lifetime	fluorescent lamps for general purposes not exceeding 8 mg. in triphosphate	10a. Deca BDE in polymeric applications								
3. Mercury in straight flu	uorescent lamps for special purposes.	10b. Lead in lead/bronze bearing shells and	bushes							
4. Mercury in other lamp	ps not specifically mentioned in this list.	11. Lead used in compliant pin connector sys	used in compliant pin connector systems.							
5. Lead in glass of catho	ode ray tubes, electronic components and fluorescent tubes.	12. Lead as a coating material for a thermal								
6a. Lead as an alloying	element in steel containing up to 0.35% lead by weight.	13a. Lead in optical and filter glass.								
6b. Lead as an alloying	element in aluminum containing up to 0.4% lead by weight.	13b. Cadmium in optical and filter glass.								
6c. Lead as an alloying	element in copper containing up to 4% lead by weight.	14. Lead in solders consisting of more than two elements for the connection between the pins and the package of microprocessors with a lead content of more than 80% and less than 85% by weight .								
7a. Lead in high melting weight or more lead).	g temperature type solders (i.e. lead based solder alloys containing 85% by	15. Lead in solders to complete a viable electrical connection between semiconductor die and carrier within integrated circuit Flip Chip packages.								
	servers, storage and storage array systems, network infrastructure equipment transmission as well as network management for telecommunications.									
Declaration Signa	ature									
	lete all of the required fields on all pages of this form. Select the "Acuired by the Requester) and click on Submit Form to have the form ret		-down. This will display the sign	nature area. Digitally sign						
Supplier Digital Signa	ature									

JIG section intentially omitted.